



IFW
PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Connell et al.

Serial No.: 10/706,212

Filed: November 12, 2003

**For: WAFER BACK SIDE COATING TO
BALANCE STRESS FROM PASSIVATION
LAYER ON FRONT OF WAFER AND BE
USED AS A DIE ATTACH ADHESIVE**

Confirmation No.: 6326

Examiner: G. Eckert II

Group Art Unit: 2815

Attorney Docket No.: 2269-5083.1US
(01-0428.01/US)

CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

January 20, 2005
Date

Leta M. Howard
Signature

Leta M. Howard
Name (Type/Print)

AMENDMENT

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

This amendment is in response to the Office Action of October 21, 2004 whose initial period of response is set to expire on January 21, 2005.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 6 of this paper.